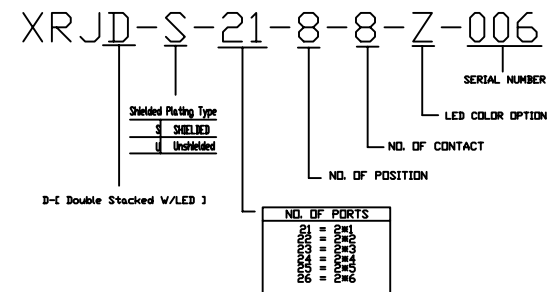


SUGGESTED PCB LAYOUT
TOP VIEW

XMULTIPLE Order Information



NOTES:

- MATERIALS:
HOUSING: HIGH TEMP. THERMOPLASTIC, PBT, BLACK, UL 94V-0
CONTACTS: T=0.35 mm PHOSPHOR BORNZE, 50u" NICKEL UNDERPLATE ON ALL AREA, 100u" TIN ON TERMINATION END, 15u" GOLD ON CONTACT AREA.
SHIELD: T=0.25 mm COPPER ZINC ALLOY PLATED WITH NICKEL
- JACK CAVITY CONFORMS TO FCC RULES AND REGULATIONS PART 68, SUBPART F
- UNSPECIFIED TOLERANCE: .XX ±0.25[0.010]
.X ±0.30[0.012]

RoHS Compliant

XMULTIPLE		CONNECTING THE INFORMATION AGE
XMULTIPLE ASIA 4F, No. 347, Yang Guang St., Neihu Chiu, Taipei, Taiwan 11475		XMULTIPLE USA 1402 Los Angeles Ave., Suite G, Simi Valley, CA 93065
THIS DRAWING IS A CONTROLLED DOCUMENT.		CUSTOMER/NO:
TITLE: Stacked RJ45 Connectors, W/LED, 8P, 8C, Shielded, Thru Hole, 2 Piece Structure		DWG NO: XRJD-S-21-8-8-Z-006
PART NO: XRJD-S-21-8-8-Z-006		DRAWN: LEON
		CHKD: JEFF
		DATE: 27/07/05
DIMENSIONS		SHEET
mm[inch]		1 of 1
		REV
		01